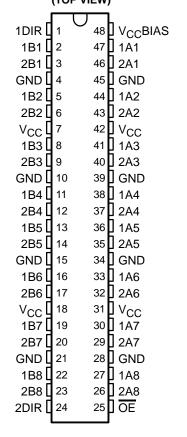
SCBS226J - JULY 1993 - REVISED DECEMBER 2001

- **Members of the Texas Instruments** Widebus™ Family
- Support the VME64 ETL Specification
- Reduced, TTL-Compatible, Input Threshold Range
- High-Drive Outputs ($I_{OH} = -60 \text{ mA}$, I_{OL} = 90 mA) Support 25- Ω Incident-Wave Switching
- **V_{CC}BIAS** Pin Minimizes Signal Distortion **During Live Insertion**
- Internal Pullup Resistor on OE Keeps **Outputs in High-Impedance State During Power Up or Power Down**
- Distributed V_{CC} and GND Pins Minimize **High-Speed Switching Noise**
- Equivalent 25- Ω Series Damping Resistor on B Port
- Bus Hold on Data Inputs Eliminates the **Need for External Pullup/Pulldown** Resistors

description

The 'ABTE16245 devices are 16-bit (dual-octal) noninverting 3-state transceivers designed for synchronous two-way communication between data buses. The control-function implementation minimizes external timing requirements. These devices can be used as two 8-bit transceivers or

SN54ABTE16245 . . . WD PACKAGE SN74ABTE16245 . . . DGG OR DL PACKAGE (TOP VIEW)



one 16-bit transceiver. They allow data transmission from the A bus to the B bus or from the B bus to the A bus, depending on the logic level at the direction-control (DIR) input. The output-enable (OE) input can be used to disable the device so that the buses are effectively isolated. When \overline{OE} is low, the device is active.

The B port has an equivalent 25- Ω series output resistor to reduce ringing. Active bus-hold inputs also are on the B port to hold unused or floating inputs at a valid logic level.

The A port provides for the precharging of the outputs via V_{CC} BIAS, which establishes a voltage between 1.3 V and 1.7 V when V_{CC} is not connected.

Active bus-hold circuitry holds unused or undriven inputs at a valid logic state. Use of pullup or pulldown resistors with the bus-hold circuitry is not recommended.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

Widebus is a trademark of Texas Instruments



SCBS226J - JULY 1993 - REVISED DECEMBER 2001

ORDERING INFORMATION

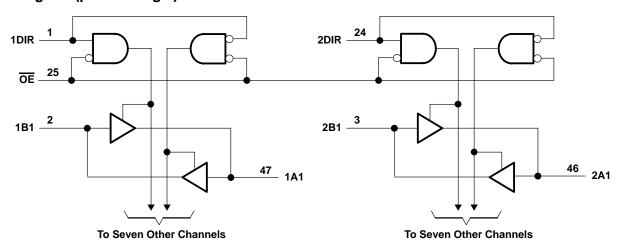
TA	PACKAGE [†]		ORDERABLE PART NUMBER	TOP-SIDE MARKING	
	°C SSOP – DL	Tube	SN74ABTE16245DL	ABTE16245	
–40°C to 85°C		Tape and reel	SN74ABTE16245DLR	ADTE 10245	
	TSSOP – DGG	Tape and reel	SN74ABTE16245DGGR	ABTE16245	
–55°C to 125°C	CFP – WD	Tube	SNJ54ABTE16245WD	SNJ54ABTE16245WD	

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

FUNCTION TABLE (each 8-bit section)

INP	UTS	ODED ATION
OE	DIR	OPERATION
L	L	A data to B bus
L	Н	B data to A bus
Н	X	Isolation

logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

Supply voltage range, V _{CC} and V _{CC} BIAS	–0.5 V to 7 V
Input voltage range, V _I (except I/O ports) (see Note 1)	0.5 V to 7 V
Voltage range applied to any output in the high state or power-off state, VO	–0.5 V to 5.5 V
Current into any output in the low state, I _O	128 mA
Input clamp current, I _{IK} (V _I < 0)	–18 mA
Output clamp current, I _{OK} (V _O < 0)	–50 mA
Package thermal impedance, θ _{JA} (see Note 2): DGG package	70°C/W
DL package	63°C/W
Storage temperature range, T _{stq}	–65°C to 150°C

[‡] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

The package thermal impedance is calculated in accordance with JESD 51-7.



NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

SCBS226J - JULY 1993 - REVISED DECEMBER 2001

recommended operating conditions (see Note 3)

					6245	SN74	ABTE16	3245	UNIT	
			MIN	NOM	MAX	MIN	NOM	MAX	UNII	
V _{CC} , V _{CC} BIAS	Supply voltage		4.5	5	5.5	4.5	5	5.5	V	
V	High-level input voltage	ŌĒ	2			2			V	
VIH	High-level input voltage	Except OE	1.6			1.6			V	
\/	Low lovel input voltage	ŌĒ			0.8			0.8	V	
VIL	Low-level input voltage	Except OE			1.4			1.4	V	
٧ _I	Input voltage		0		VCC	0		Vcc	V	
lou	High lovel output ourrent	B bus			-12			-12	mA	
ЮН	High-level output current	A bus			-24			-60	mA	
la.	Low lovel output oursest	B bus			12			12	A	
lOL	Low-level output current	A bus			64			90	mA	
Δt/Δν	Input transition rise or fall rate	Outputs enabled			10			10	ns/V	
T _A	Operating free-air temperature		-55		125	-40		85	°C	

NOTE 3: All unused control inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

SCBS226J - JULY 1993 - REVISED DECEMBER 2001

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DAF	DAMETED	TEST 00	NDITIONS	SN	54ABTE1	6245	SN	74ABTE	16245	LIAUT	
PAR	RAMETER	1551 CC	ONDITIONS	MIN	TYP [†]	MAX	MIN	TYP [†]	MAX	UNIT	
VIK		V _{CC} = 4.5 V,	I _I = -18 mA			-1.2			-1.2	V	
		V _{CC} = 5.5 V,	I _{OH} = -100 μA			V _{CC} -0.2			V _{CC} -0.2		
	B port	V 45V	I _{OH} = -1 mA	2.4			2.4				
V	,	V _{CC} = 4.5 V	I _{OH} = -12 mA	2			2	2			
VOH		$V_{CC} = 5.5 \text{ V},$	$I_{OH} = -1 \text{ mA}$			4.5			4.5	V	
	A port	V 45V	I _{OH} = -32 mA	2.4			2.4				
		V _{CC} = 4.5 V	I _{OH} = -64 mA				2				
	D nort	V 45V	I _{OL} = 1 mA			0.4			0.4		
V	B port	V _{CC} = 4.5 V	I _{OL} = 12 mA						0.8	V	
VOL	A port	V _{CC} = 4.5 V	I _{OL} = 64 mA			0.55			0.55	V	
	A port	vCC = 4.5 v	I _{OL} = 90 mA						0.9		
	I _{I(hold)} B port	V 45V	V _I = 0.8 V	100			100				
I _I (hold)		V _{CC} = 4.5 V	V _I = 2 V	-100			-100			μΑ	
		$V_{CC} = 5.5 \text{ V},$	V _I = 0 to 5.5 V			±500			±500		
1.	Control inputs	V _{CC} = 5.5 V,	V _I = V _{CC} or GND			±1			±1		
tı	A or B ports	vCC = 5.5 v,	AL = ACC OLGIAD			±20			±20	μΑ	
lozh [‡]	A port	$V_{CC} = 5.5 \text{ V},$	V _O = 2.7 V			10			10	μΑ	
lozL [‡]	A port	V _{CC} = 5.5 V,	V _O = 0.5 V			-10			-10	μΑ	
1-	A port	V 55V	V- 25V	-50	-120	-180	-50		-180	mA	
Ю	B port	V _{CC} = 5.5 V,	V _O = 2.5 V	-25	-52	-90	-25		-90	mA	
l _{off}		$V_{CC} = 0$, V_{I} or $V_{O} \le$	4.5 V, V _{CC} BIAS = 0			±100			±100	μΑ	
			Outputs high		28	36		28	36		
Icc	I _{CC} A or B ports	$V_{CC} = 5.5 \text{ V}, I_{O} = 0,$ $V_{I} = V_{CC} \text{ or GND}$	Outputs low		38	48		38	48	mA	
		V1 = VCC 01 014B	Outputs disabled		20	32		20	32		
loop	A or B ports	V _{CC} = 5 V,	OE high		0.02			0.02		mA/	
ICCD	A OI B POILS	C _L = 50 pF	OE low		0.33			0.33		MHz	
C _i	Control inputs	V _I = 2.5 V or 0.5 V				10		2.5	4	pF	
C _{io}	I/O ports	$V_0 = 2.5 \text{ V or } 0.5 \text{ V}$				13		4.5	8	pF	

[†] All typical values are at V_{CC} = 5 V, T_A = 25°C. ‡ The parameters I_{OZH} and I_{OZL} include the input leakage current.

SCBS226J - JULY 1993 - REVISED DECEMBER 2001

live-insertion specifications over recommended operating free-air temperature range

DADA	METER		SN54	ABTE16	6245	SN74ABTE16245			UNIT		
PARAI	VIETER		TEST CONDITIONS				MAX	MIN	TYP [†]	MAX	UNIT
loo (Va	a PIAC)	$V_{CC} = 0 \text{ to } 4.5$ $I_{O(DC)} = 0$	V, V _{CC} BIAS = 4.5 V to 5.5		250	700		250	700		
ICC (VC	:Свіко)	$V_{CC} = 4.5 \text{ V to}$ $I_{O(DC)} = 0$	5.5 V [‡] , V _{CC} BIAS = 4.5 V t			20			20	μΑ	
Va	A nort	Vaa - 0	V _{CC} BIAS = 4.5 V to 5.5 V	/	1.1	1.5	1.9	1.1	1.5	1.9	V
Vo	$\begin{array}{c c} A \text{ bout} & A \text{ bot} \\ \hline \end{array}$		V _{CC} BIAS = 4.75 V to 5.2	1.3	1.5	1.7	1.3	1.5	1.7	V	
la	A port Vac - 0		VCCBIAS = 4.5 V	V _O = 0	-20		-100	-20		-100	μΑ
10	A port	VCC = 0,	V (ССЫАЗ = 4.5 V	V _O = 3 V	20		100	20		100	μΑ

[†] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

switching characteristics over recommended ranges of supply voltage and operating free-air temperature, C_L = 50 pF (unless otherwise noted) (see Figure 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	۷ ₀ ۲٫	V _{CC} = 5 V, T _A = 25°C			SN54ABTE16245		SN74ABTE16245	
	(1141 01)	(0011 01)	MIN	TYP	MAX	MIN	MAX	MIN	MAX	
^t PLH	Α	В	1.5	3.3	4.2	1.5	5.4	1.5	5.2	ns
^t PHL	A	Ь	1.5	3.8	4.6	1.5	5.4	1.5	5.2	115
^t PLH	В	۸	1.5	3	3.8	1.5	4.7	1.5	4.5	no
^t PHL	Ь	Α	1.5	3.1	4	1.5	4.7	1.5	4.5	ns
^t PZH	ŌĒ	А	2	3.9	5.3	2	6.4	2	6.2	ns
tpZL	OE .		2	4.4	5.9	2	7	2	6.8	115
^t PZH		В	2	4.5	6	2	7.3	2	7.1	
tPZL	ŌĒ	В	2	5	6.4	2	7.5	2	7.3	ns
^t PHZ	ŌĒ	Δ.	2	4.9	5.9	2	7	2	6.7	
^t PLZ] OE	A	2	3.7	4.6	2	5.4	2	5.1	ns
^t PHZ	ŌĒ	В	2	5.2	6.2	2	7.2	2	7	no
^t PLZ]		2	4	5	2	5.8	2	5.5	ns



[‡] VCC - 0.5 V < VCCBIAS

SCBS226J – JULY 1993 – REVISED DECEMBER 2001

extended switching characteristics over recommended ranges of supply voltage and operating free-air temperature, $C_L = 50$ pF (unless otherwise noted) (see Figure 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD	V(V _{CC} = 5 V, T _A = 25°C			SN54ABTE16245		SN74ABTE16245		
	(IIVI O1)	(0011 01)		MIN	TYP	MAX	MIN	MAX	MIN	MAX		
t _{PLH}	В	А	Rχ = 13 Ω	1.5	3.2	4	1.5	5	1.5	4.8	ns	
t _{PHL}	ם	^	Λχ = 13 22	1.5	3.8	4.7	1.5	5.8	1.5	5.6	115	
tPLH	В	А	Rχ = 26 Ω	1.5	3.1	4	1.5	4.8	1.5	4.6	ns	
tPHL	ם	^	Λχ = 20 12	1.5	3.5	4.4	1.5	5.2	1.5	4.9	115	
^t PLH	В	Α	R _X = 56 Ω	1.5	3	3.8	1.5	4.7	1.5	4.5	ns	
t _{PHL}	Б	A	$K\chi = 50.22$	1.5	3.3	4.2	1.5	5.1	1.5	4.7	115	
	В	А	R _X = Open		0.1	0.6		2		2		
^t sk(p)	А	В	R _X = Open		0.4	0.8		2		2	ns	
	В	А	$R_X = 26 \Omega$		0.3	8.0		2		2		
	В	А	R _X = Open		0.3	0.7		1.3		1.3		
tsk(o)	Α	В	R _X = Open		0.7	1.1		1.3		1.3	ns	
	В	А	$R_X = 26 \Omega$		0.5	1		1.3		1.3		
tt†	В	А	$R_X = 26 \Omega$	0.5	0.8	1.5	0.5	1.5	0.5	1.5	ns	
t _t ‡	Α	В	R _X = Open	3.5	5.5	7.3	3.5	8.1	3.5	7.9	ns	

 $[\]dagger$ t_t is measured between 1 V and 2 V of the output waveform.

extended output characteristics over recommended ranges of supply voltage and operating free-air temperature, $C_L = 50$ pF (see Figures 1 and 2)

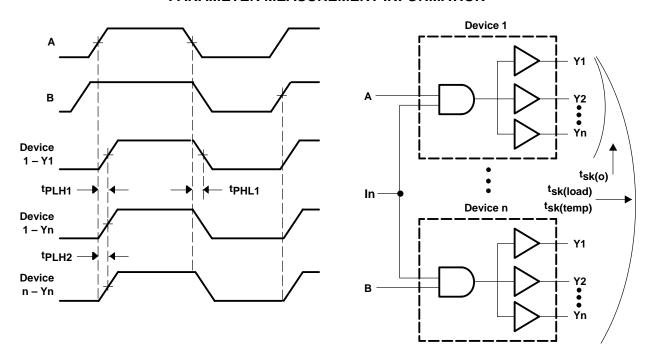
DADAMETED	RAMETER FROM TO (OUTPUT) TEST CONDITIONS LO		TEST CONDITIONS	LOAD	SN54ABTE16245		SN74ABTE16245		UNIT
PARAMETER			LOAD	MIN	MAX	MIN	MAX	UNIT	
4	Α	В	V _{CC} = constant,			3		2.5	
^t sk(temp)	В	Α	$\Delta T_A = 20^{\circ}C$	$R\chi = 56 \Omega$		4.5		4	ns
^t sk(load)	В	В	V _{CC} = constant, Temperature = constant	$R_X = 13, 26,$ or 56Ω		4.5		4	ns



[‡]t_t is measured between 10% and 90% of the output waveform.

SCBS226J - JULY 1993 - REVISED DECEMBER 2001

PARAMETER MEASUREMENT INFORMATION

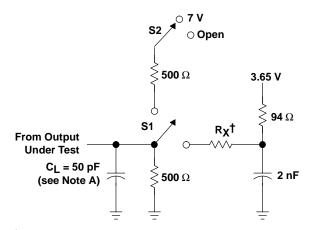


- NOTES: A. Pulse skew, $t_{sk(p)}$, is defined as the difference in propagation-delay times t_{PLH1} and t_{PHL1} on the same terminal at identical operating conditions.
 - B. Output skew, t_{Sk(0)}, is defined as the difference in propagation delay of any two outputs of the same device switching in the same direction (e.g., |t_{PLH1} t_{PLH2}|).
 - C. Temperature skew, $t_{sk(temp)}$, is the output skew of two devices, both having the same value of $V_{CC} \pm 1\%$ and with package temperature differences of 20°C.
 - D. Load skew, $t_{sk(load)}$, is measured with R_X in Figure 2 at 13 Ω for one unit and 56 Ω for the other unit.

Figure 1. Voltage Waveforms for Extended Characteristics

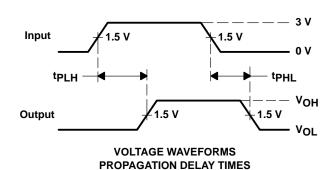
SCBS226J - JULY 1993 - REVISED DECEMBER 2001

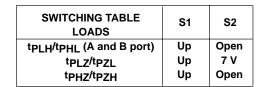
PARAMETER MEASUREMENT INFORMATION



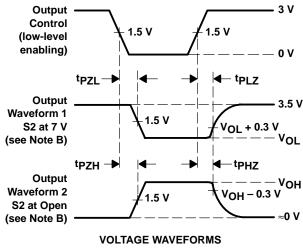
 $\dagger R_{X} = 13, 26, or 56 \Omega$

LOAD CIRCUIT FOR OUTPUTS





EXTENDED SWITCHING TABLE	S1	S2
LOADS	31	32
tpLH/tpHL/tsk (A port)	Down	Х
tpLH/tpHL/tsk (B port)	Up	Open
t _t (A port) (see Note E)	Down	Х
t _t (B port) (see Note F)	Up	Open



ENABLE AND DISABLE TIMES

- NOTES: A. C_I includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_Q = 50 \Omega$, $t_f \leq$ 2.5 ns, $t_f \leq$ 2.5 ns.
 - D. The outputs are measured one at a time with one transition per measurement.
 - E. t_t is measured between 1 V and 2 V of the output waveform.
 - F. t_t is measured between 10% and 90% of the output waveform.

Figure 2. Load Circuit and Voltage Waveforms







i.com 28-Feb-2005

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
5962-9677501QXA	ACTIVE	CFP	WD	48	1	None	Call TI	Level-NC-NC-NC
SN74ABTE16245DGGR	ACTIVE	TSSOP	DGG	48	2000	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM
SN74ABTE16245DL	ACTIVE	SSOP	DL	48	25	None	CU NIPDAU	Level-1-235C-UNLIM
SN74ABTE16245DLR	ACTIVE	SSOP	DL	48	1000	None	CU NIPDAU	Level-1-235C-UNLIM
SNJ54ABTE16245WD	ACTIVE	CFP	WD	48	1	None	Call TI	Level-NC-NC-NC

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - May not be currently available - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

None: Not yet available Lead (Pb-Free).

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean "Pb-Free" and in addition, uses package materials that do not contain halogens, including bromine (Br) or antimony (Sb) above 0.1% of total product weight.

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDECindustry standard classifications, and peak solder temperature.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products		Applications	
Amplifiers	amplifier.ti.com	Audio	www.ti.com/audio
Data Converters	dataconverter.ti.com	Automotive	www.ti.com/automotive
DSP	dsp.ti.com	Broadband	www.ti.com/broadband
Interface	interface.ti.com	Digital Control	www.ti.com/digitalcontrol
Logic	logic.ti.com	Military	www.ti.com/military
Power Mgmt	power.ti.com	Optical Networking	www.ti.com/opticalnetwork
Microcontrollers	microcontroller.ti.com	Security	www.ti.com/security
		Telephony	www.ti.com/telephony
		Video & Imaging	www.ti.com/video
		Wireless	www.ti.com/wireless

Mailing Address: Texas Instruments

Post Office Box 655303 Dallas, Texas 75265

Copyright © 2005, Texas Instruments Incorporated

Copyright © Each Manufacturing Company.

All Datasheets cannot be modified without permission.

This datasheet has been download from:

www.AllDataSheet.com

100% Free DataSheet Search Site.

Free Download.

No Register.

Fast Search System.

www.AllDataSheet.com